

REVISIONS

LTR	DESCRIPTION	DATE (YR-MO-DA)	APPROVED
C	Convert to military drawing format. Add LCC package. Editorial changes throughout. Change code ident. no. from 14933 to 67268.	88-01-27	M. A. Frye
D	Update boilerplate to MIL-PRF-38535 requirements. Correct title to accurately reflect device function. - CFS	05-03-23	Thomas M. Hess

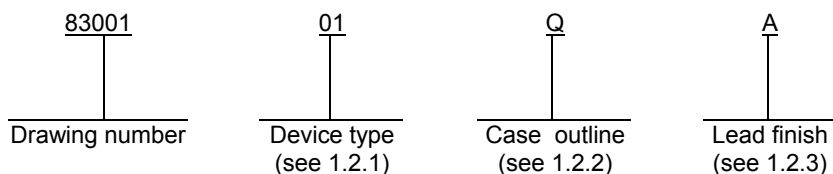
THE ORIGINAL FIRST SHEET OF THIS DRAWING HAS BEEN REPLACED.

REV																					
SHEET																					
REV	D	D	D	D	D	D	D	D	D	D	D	D	D								
SHEET	15	16	17	18	19	20	21	22	23	24	25	26	27								
REV STATUS OF SHEETS	REV			D	D	D	D	D	D	D	D	D	D	D	D	D	D	D	D	D	
	SHEET			1	2	3	4	5	6	7	8	9	10	11	12	13	14				
PMIC N/A	PREPARED BY James E. Jamison				DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990 http://www.dscc.dla.mil																
STANDARD MICROCIRCUIT DRAWING THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE AMSC N/A	CHECKED BY D. A. DiGenzo																				
	APPROVED BY Michael A. Frye																				
	DRAWING APPROVAL DATE 83-04-07																				
	REVISION LEVEL D																				
				SIZE A	CAGE CODE 67268	83001															
				SHEET 1 OF 27																	

1. SCOPE

1.1 Scope. This drawing describes device requirements for MIL-STD-883 compliant, non-JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A.

1.2 Part or Identifying Number (PIN). The complete PIN is as shown in the following example:



1.2.1 Device type(s). The device type(s) identify the circuit function as follows:

<u>Device type</u>	<u>Generic number</u>	<u>Frequency</u>	<u>Circuit function</u>
01	Z8536/Z0853604	4 MHz	Counter timer and parallel input/output peripheral unit
02	Z8536A/Z0853606	6 MHz	Counter timer and parallel input/output peripheral unit

1.2.2 Case outline(s). The case outline(s) are as designated in MIL-STD-1835 and as follows:

<u>Outline letter</u>	<u>Descriptive designator</u>	<u>Terminals</u>	<u>Package style</u>
Q	GDIP1-T40 or CDIP2-T40	40	Dual-in-line
Y	CQCC1-N44	44	Square leadless chip carrier

1.2.3 Lead finish. The lead finish is as specified in MIL-PRF-38535, appendix A.

1.3 Absolute maximum ratings.

Supply voltage range (V_{CC})	-0.3 V dc to +7.0 V dc <u>1/</u>
Voltage on any pin	-0.3 V dc to $V_{CC} + 0.3$ V dc <u>1/</u>
Storage temperature range	-65°C to +150°C
Maximum power dissipation (P_D) at -55°C	1.2 W
Maximum power dissipation (P_D) at +125°C	0.60 W
Lead temperature (soldering, 10 seconds)	+270°C
Maximum junction temperature (T_J) at $T_C = +125^\circ\text{C}$	+170°C
Thermal resistance, junction-to-case (θ_{JC}):	
Cases Q and Y	See MIL-STD-1835

1/ Voltages are referenced to ground.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A	83001
	REVISION LEVEL D	SHEET 2

1.4 Recommended operating conditions.

Supply voltage range (V_{CC})	+4.5 V dc to +5.5 V dc
Minimum high level input voltage (V_{IH})	2.4 V dc
Maximum low level input voltage (V_{IL})	0.8 V dc
Frequency of operation:	
Device type 01	0.5 to 4.0 MHz
Device type 02	0.5 to 6.0 MHz
Case operating temperature range (T_C)	-55°C to +125°C
Maximum clock rise time	20 ns
Maximum clock fall time	20 ns

<u>Timing parameter</u>	<u>Reference number 1/</u>	<u>Minimum</u>	<u>Maximum</u>	<u>Units</u>
Trigger input to PCLK setup time (timer mode) 2/	71	150		ns
Trigger input to counter input setup time (counter mode) 2/	72	150		ns
Trigger input pulse width (high or low)	73	200		ns
Gate input to PCLK setup time (timer mode) 2/	74	100		ns
Gate input to counter input setup time (counter mode) 2/	75	100		ns
Gate input to PCLK hold time (timer mode) 2/	76	100		ns
Gate input to counter input hold time (counter mode) 2/	77	100		ns
PCLK to counter output delay (timer mode)	78		475	ns
Counter input to counter output delay (counter mode)	79		475	ns

1/ The reference number refers to the identified parameter on figure 3 for device type 01 only.

2/ These parameters must be met to guarantee trigger or gate are valid for the next counter/timer cycle.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 3

2. APPLICABLE DOCUMENTS

2.1 Government specification, standards, and handbooks. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

DEPARTMENT OF DEFENSE SPECIFICATION

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883 - Test Method Standard Microcircuits.
 MIL-STD-1835 - Interface Standard Electronic Component Case Outlines.

DEPARTMENT OF DEFENSE HANDBOOKS

MIL-HDBK-103 - List of Standard Microcircuit Drawings.
 MIL-HDBK-780 - Standard Microcircuit Drawings.

(Copies of these documents are available online at <http://assist.daps.dla.mil/quicksearch/> or <http://assist.daps.dla.mil> or from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein. Product built to this drawing that is produced by a Qualified Manufacturer Listing (QML) certified and qualified manufacturer or a manufacturer who has been granted transitional certification to MIL-PRF-38535 may be processed as QML product in accordance with the manufacturers approved program plan and qualifying activity approval in accordance with MIL-PRF-38535. This QML flow as documented in the Quality Management (QM) plan may make modifications to the requirements herein. These modifications shall not affect form, fit, or function of the device. These modifications shall not affect the PIN as described herein. A "Q" or "QML" certification mark in accordance with MIL-PRF-38535 is required to identify when the QML flow option is used.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535, appendix A and herein.

3.2.1 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.

3.2.2 Terminal connections. The terminal connections shall be as specified on figure 1.

3.2.3 Logic functions. The logic functions shall be as specified on figure 2.

3.2.4 Timing waveforms. The timing waveforms shall be as specified on figure 3.

3.3 Electrical performance characteristics. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full case operating temperature range.

3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 4

3.5 Marking. Marking shall be in accordance with MIL-PRF-38535, appendix A. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked.

3.5.1 Certification/compliance mark. A compliance indicator "C" shall be marked on all non-JAN devices built in compliance to MIL-PRF-38535, appendix A. The compliance indicator "C" shall be replaced with a "Q" or "QML" certification mark in accordance with MIL-PRF-38535 to identify when the QML flow option is used.

3.6 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6 herein). The certificate of compliance submitted to DSCC-VA prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-PRF-38535, appendix A and the requirements herein.

3.7 Certificate of conformance. A certificate of conformance as required in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.

3.8 Notification of change. Notification of change to DSCC-VA shall be required for any change that affects this drawing.

3.9 Verification and review. DSCC, DSCC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 5

TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions 4.5 V ≤ V _{CC} ≤ 5.5 V, -55°C ≤ T _C ≤ +125°C unless otherwise specified	Device type	Group A subgroups	Limits		Unit	
					Min	Max		
High level input voltage	V _{IH}		All	1, 2, 3	2.2	V _{CC} + 0.3 <u>1/</u>	V	
Low level input voltage	V _{IL}				-0.3 <u>1/</u>	0.8		
Low level output voltage	V _{OL}	I _{OL} = 2.0 mA				0.4		
High level output voltage	V _{OH}	I _{OH} = -250 μA			2.4			
Power supply current	I _{CC}	V _{CC} = 5.5 V Outputs open	All	1, 2, 3		200	mA	
Input capacitance	C _{IN}		All	4		10 <u>1/</u>	pF	
Output capacitance	C _{OUT}					15 <u>1/</u>		
Bidirectional capacitance	C _{I/O}					20 <u>1/</u>		
Output leakage current low, open drain outputs	I _{LOL}	0.4 V ≤ V _{OUT} ≤ 2.4 V	All	1, 2, 3	-10	+10	μA	
Output leakage current high, open drain outputs	I _{LOH}				-10	+10		
Input low current (input and bidirectional)	I _{IL}				0.4 V ≤ V _{IN} ≤ 2.4 V	-10		+10
Input high current (input and bidirectional)	I _{IH}					-10		+10
Maximum frequency <u>1/</u>	f _{MAX}		01	9, 10, 11	4.0		MHz	
			02		6.0			
Functional tests	I _{CEX}	See paragraph 4.3.1c.	All	7, 8				

See footnotes at end of table.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 6

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions 4.5 V ≤ V _{CC} ≤ 5.5 V, -55°C ≤ T _C ≤ +125°C unless otherwise specified	Device type	Group A subgroups	Limits		Unit
					Min	Max	
PCLK cycle time	t _{CYC1}	Reference number 1. <u>2/ 3/ 4/</u>	01	9, 10, 11	250	4000	ns
			02		165	4000	
PCLK width high <u>1/</u>	t _{PWH1}	Reference number 2. <u>2/ 3/ 4/</u>	01	9, 10, 11	105	2000	ns
			02		70	2000	
PCLK width low <u>1/</u>	t _{PWL1}	Reference number 3. <u>2/ 3/ 4/</u>	01	9, 10, 11	105	2000	ns
			02		70	2000	
PCLK rise time <u>1/</u>	t _{RC1}	Reference number 4. <u>2/ 3/ 4/</u>	01	9, 10, 11		20	ns
			02			10	
PCLK fall time <u>1/</u>	t _{FC1}	Reference number 5. <u>2/ 3/ 4/</u>	01	9, 10, 11		20	ns
			02			15	
INTACK to PCLK setup time <u>1/</u>	t _{SHL1} , t _{SLH1}	Reference number 6. <u>2/ 3/ 4/</u>	All	9, 10, 11	100		ns
INTACK to PCLK hold time <u>1/</u>	t _{HHL1} , t _{HLH1}	Reference number 7. <u>2/ 3/ 4/</u>	All	9, 10, 11	0		ns
INTACK to RD setup time <u>1/</u>	t _{SHL2} , t _{SLH2}	Reference number 8. <u>2/ 3/ 4/</u>	All	9, 10, 11	200		ns
INTACK to RD hold time <u>1/</u>	t _{HHL2} , t _{HLH2}	Reference number 9. <u>2/ 3/ 4/</u>	All	9, 10, 11	0		ns
INTACK to WR setup time <u>1/</u>	t _{SHL3} , t _{SLH3}	Reference number 10. <u>2/ 3/ 4/</u>	All	9, 10, 11	200		ns
INTACK to WR↑ hold time <u>1/</u>	t _{HHL3} , t _{HLH3}	Reference number 11. <u>2/ 3/ 4/</u>	All	9, 10, 11	0		ns
Address to RD↓ setup time	t _{SHL4} , t _{SLH4}	Reference number 12. <u>2/ 3/ 4/</u>	All	9, 10, 11	80		ns
Address to RD↑ hold time <u>1/</u>	t _{HHL4} , t _{HLH4}	Reference number 13. <u>2/ 3/ 4/</u>	All	9, 10, 11	0		ns
Address to WR↓ setup time	t _{SHL5} , t _{SLH5}	Reference number 14. <u>2/ 3/ 4/</u>	All	9, 10, 11	80		ns
Address to WR↑ hold time <u>1/</u>	t _{HHL5} , t _{HLH5}	Reference number 15. <u>2/ 3/ 4/</u>	All	9, 10, 11	0		ns
CE low to RD↓ setup time <u>5/</u>	t _{SHL6}	Reference number 16. <u>2/ 3/ 4/</u>	All	9, 10, 11	0		ns

See footnotes at end of table.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 7

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions 4.5 V ≤ V _{CC} ≤ 5.5 V, -55°C ≤ T _C ≤ +125°C unless otherwise specified	Device type	Group A subgroups	Limits		Unit
					Min	Max	
CE high to RD↓ setup time 1/ 5/	t _{SLH7}	Reference number 17. 2/ 3/ 4/	01	9, 10, 11	100		ns
			02		70		
CE to RD↑ hold time 5/	t _{HHL6} , t _{HLH6}	Reference number 18. 2/ 3/ 4/	All	9, 10, 11	0		ns
CE low to WR↓ setup time	t _{SHL8}	Reference number 19. 2/ 3/ 4/	All	9, 10, 11	0		ns
CE high to WR↓ setup time 1/	t _{SLH9}	Reference number 20. 2/ 3/ 4/	01	9, 10, 11	100		ns
			02		70		
CE to WR↑ hold time	t _{HHL7} , t _{HLH7}	Reference number 21. 2/ 3/ 4/	All	9, 10, 11	0		ns
RD to low width 1/ 5/	t _{PWL2}	Reference number 22. 2/ 3/ 4/	01	9, 10, 11	390		ns
			02		250		
RD↓ to read data active delay 1/	t _{PHL1} , t _{PLH1}	Reference number 23. 2/ 3/ 4/	All	9, 10, 11	0		ns
RD↓ to read data valid delay 1/	t _{PHL2} , t _{PLH2}	Reference number 24. 2/ 3/ 4/	01	9, 10, 11		255	ns
			02			180	
RD↑ to read data not valid delay 1/	t _{PHL3} , t _{PLH3}	Reference number 25. 2/ 3/ 4/	All	9, 10, 11	0		ns
RD↑ to read data float delay 6/	t _{PHZ1} , t _{PZH1}	Reference number 26. 2/ 3/ 4/	01	9, 10, 11		70	ns
			02			45	
WR low width 1/	t _{PWL3}	Reference number 27. 2/ 3/ 4/	01	9, 10, 11	390		ns
			02		250		
Write data to WR↓ setup time 1/	t _{SHL10} , t _{SLH10}	Reference number 28. 2/ 3/ 4/	All	9, 10, 11	0		ns
Write data to WR↑ hold time 1/	t _{HHL8} , t _{HLH8}	Reference number 29. 2/ 3/ 4/	All	9, 10, 11	0		ns
Valid access recovery time 1/ 7/	t _{CYC2}	Reference number 30. 2/ 3/ 4/	01	9, 10, 11	1000		ns
			02		650		
Pattern match to INT delay (bit port) 1/	t _{PHL4}	Reference number 31. 2/ 3/ 4/	All	9, 10, 11		2*(t _{CYC1}) + 800	ns
ACKIN to INT delay (port with handshake) 1/ 8/	t _{PHL5}	Reference number 32. 2/ 3/ 4/	All	9, 10, 11		10*(t _{CYC1}) + 600	ns

See footnotes at end of table.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 8

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions 4.5 V ≤ V _{CC} ≤ 5.5 V, -55°C ≤ T _C ≤ +125°C unless otherwise specified	Device type	Group A subgroups	Limits		Unit
					Min	Max	
Counter input to $\overline{\text{INT}}$ delay (counter mode) <u>1/</u>	t _{PHL6}	Reference number 33. <u>2/ 3/ 4/</u>	All	9, 10, 11		2*(t _{CYC1}) + 700	ns
PCLK to $\overline{\text{INT}}$ delay (timer mode) <u>1/</u>	t _{PHL7}	Reference number 34. <u>2/ 3/ 4/</u>	All	9, 10, 11		3*(t _{CYC1}) + 700	ns
$\overline{\text{INTACK}}$ to $\overline{\text{RD}}\downarrow$ (acknowledge setup time) <u>1/ 9/</u>	t _{SHL11} , t _{SLH11}	Reference number 35. <u>2/ 3/ 4/</u>	01 02	9, 10, 11	350 250		ns
$\overline{\text{RD}}$ acknowledge width <u>1/</u>	t _{PWL4}	Reference number 36. <u>2/ 3/ 4/</u>	01 02	9, 10, 11	350 250		ns
$\overline{\text{RD}}\downarrow$ (acknowledge) to read data valid delay <u>1/</u>	t _{PHL8} , t _{PLH8}	Reference number 37. <u>2/ 3/ 4/</u>	01 02	9, 10, 11		250 180	ns
$\overline{\text{INTACK}}\downarrow$ to IEO \downarrow delay <u>1/ 9/</u>	t _{PHL9}	Reference number 38. <u>2/ 3/ 4/</u>	01 02	9, 10, 11		350 250	ns
IEI to IEO delay <u>1/ 9/</u>	t _{PHL10}	Reference number 39. <u>2/ 3/ 4/</u>	01 02	9, 10, 11		150 100	ns
IEI to $\overline{\text{RD}}\downarrow$ (acknowledge) setup time <u>1/ 9/</u>	t _{SHL12} , t _{SLH12}	Reference number 40. <u>2/ 3/ 4/</u>	01 02	9, 10, 11	100 70		ns
IEI to $\overline{\text{RD}}\uparrow$ (acknowledge) hold time <u>1/</u>	t _{HHL9} , t _{HLH9}	Reference number 41. <u>2/ 3/ 4/</u>	01 02	9, 10, 11	100 70		ns
$\overline{\text{RD}}\downarrow$ (acknowledge) to $\overline{\text{INT}}$ delay <u>1/</u>	t _{PHL11}	Reference number 42. <u>2/ 3/ 4/</u>	All	9, 10, 11		600	ns
Data input to ACKIN \downarrow setup time <u>1/</u>	t _{SHL13} , t _{SLH13}	Reference number 43. <u>2/ 3/ 4/</u>	All	9, 10, 11	0		ns
ACKIN \downarrow to RFD \downarrow delay <u>1/</u>	t _{PHL12}	Reference number 45. <u>2/ 3/ 4/</u>	All	9, 10, 11	0		ns
RFD \uparrow to ACKIN \downarrow delay <u>1/</u>	t _{HHL10}	Reference number 48. <u>2/ 3/ 4/</u>	All	9, 10, 11	0		ns
Data out to DAV \downarrow setup time <u>1/ 10/</u>	t _{PHL13} , t _{PLH13}	Reference number 49. <u>2/ 3/ 4/</u>	01 02	9, 10, 11	25 20		ns
DAV \downarrow to ACKIN \downarrow delay <u>1/</u>	t _{SHL14}	Reference number 50. <u>2/ 3/ 4/</u>	All	9, 10, 11	0		ns
Data out to ACKIN \downarrow hold time <u>1/</u>	t _{HHL11} , t _{HLH11}	Reference number 51. <u>2/ 3/ 4/</u>	All	9, 10, 11	2*(t _{CYC1})		ns

See footnotes at end of table.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 9

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions 4.5 V ≤ V _{CC} ≤ 5.5 V, -55°C ≤ T _C ≤ +125°C unless otherwise specified	Device type	Group A subgroups	Limits		Unit
					Min	Max	
$\overline{\text{ACKIN}}\downarrow$ to $\overline{\text{DAV}}\uparrow$ delay 1/	t _{PLH14}	Reference number 52. 2/ 3/ 4/	All	9, 10, 11	2*(t _{CYC1})		ns
RFD \downarrow to ACKIN \uparrow delay (interlocked handshake) 1/	t _{HLH12}	Reference number 54. 2/ 3/ 4/	All	9, 10, 11	0		ns
$\overline{\text{ACKIN}}\uparrow$ (DAV) \uparrow to RFD \uparrow delay (interlocked and three wire handshake) 1/	t _{PLH15}	Reference number 55. 2/ 3/ 4/	All	9, 10, 11	0		ns
DAV \uparrow ACKIN \uparrow to (RFD) \uparrow (interlocked and three wire handshake) 1/	t _{HLH13}	Reference number 56. 2/ 3/ 4/	All	9, 10, 11	0		ns
$\overline{\text{ACKIN}}\uparrow$ (RFD) \uparrow to $\overline{\text{DAV}}\downarrow$ delay (interlocked and three wire handshake) 1/	t _{PLH16}	Reference number 57. 2/ 3/ 4/	All	9, 10, 11	0		ns
$\overline{\text{DAV}}\downarrow$ to DAC \uparrow delay (input three wire handshake) 1/	t _{PLH17}	Reference number 58. 2/ 3/ 4/	All	9, 10, 11	0		ns
Data input to DAC \uparrow hold time (three wire handshake) 1/	t _{HHL14} , t _{HLH14}	Reference number 59. 2/ 3/ 4/	All	9, 10, 11	0		ns
DAC \uparrow to $\overline{\text{DAV}}\downarrow$ delay (input three wire handshake) 1/	t _{HLH15}	Reference number 60. 2/ 3/ 4/	All	9, 10, 11	0		ns
$\overline{\text{DAV}}\uparrow$ to DAC \downarrow delay (input three wire handshake) 1/	t _{PHL18}	Reference number 61. 2/ 3/ 4/	All	9, 10, 11	0		ns
$\overline{\text{DAV}}\downarrow$ to DAC \uparrow delay (output three wire handshake) 1/	t _{SLH15}	Reference number 62. 2/ 3/ 4/	All	9, 10, 11	0		ns
Data output to DAC \uparrow hold time (three wire handshake) 1/	t _{PHL19} , t _{PLH19}	Reference number 63. 2/ 3/ 4/	All	9, 10, 11	2*(t _{CYC1})		ns
DAC \uparrow to $\overline{\text{DAV}}\uparrow$ delay (output three wire handshake) 1/	t _{PHL20}	Reference number 64. 2/ 3/ 4/	All	9, 10, 11	2*(t _{CYC1})		ns
$\overline{\text{DAV}}\uparrow$ to DAC \downarrow delay (output three wire handshake) 1/	t _{HHL16}	Reference number 65. 2/ 3/ 4/	All	9, 10, 11	0		ns
Counter input cycle time 1/	t _{CYC3}	Reference number 66. 2/ 3/ 4/	01 02	9, 10, 11	500 330		ns
Counter input high width 1/	t _{PWH5}	Reference number 67. 2/ 3/ 4/	01 02	9, 10, 11	230 150		ns

See footnotes at end of table.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 10

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions 4.5 V ≤ V _{CC} ≤ 5.5 V, -55°C ≤ T _C ≤ +125°C unless otherwise specified	Device type	Group A subgroups	Limits		Unit
					Min	Max	
Counter input low width <u>1/</u>	t _{PWL5}	Reference number 68. <u>2/ 3/ 4/</u>	01	9, 10, 11	230		ns
			02		150		
Counter input fall time <u>1/</u>	t _{FC2}	Reference number 69. <u>2/ 3/ 4/</u>	01	9, 10, 11		20	ns
			02			15	
Counter input rise time <u>1/</u>	t _{RC2}	Reference number 70. <u>2/ 3/ 4/</u>	01	9, 10, 11		20	ns
			02			15	
$\overline{RD}\downarrow$ to $\overline{REQ}\downarrow$ delay	t _{PHL21}	Reference number 80. <u>2/ 3/ 4/</u>	01	9, 10, 11		500	ns
$\overline{RD}\downarrow$ to $\overline{WAIT}\downarrow$ delay	t _{PHL22}	Reference number 81. <u>2/ 3/ 4/</u>	01	9, 10, 11		500	ns
$\overline{WR}\downarrow$ to $\overline{REQ}\downarrow$ delay	t _{PHL23}	Reference number 82. <u>2/ 3/ 4/</u>	01	9, 10, 11		500	ns
$\overline{WR}\downarrow$ to $\overline{WAIT}\downarrow$ delay	t _{PHL24}	Reference number 83. <u>2/ 3/ 4/</u>	01	9, 10, 11		500	ns
PCLK \downarrow to $\overline{REQ}\uparrow$ delay	t _{PHL25}	Reference number 84. <u>2/ 3/ 4/</u>	01	9, 10, 11		300	ns
PCLK \downarrow to $\overline{WAIT}\uparrow$ delay	t _{PHL26}	Reference number 85. <u>2/ 3/ 4/</u>	01	9, 10, 11		300	ns
$\overline{ACKIN}\downarrow$ to $\overline{REQ}\uparrow$ delay <u>8/</u>	t _{PHL27}	Reference number 86. <u>2/ 3/ 4/</u>	01	9, 10, 11		8*(t _{CYC1}) + 1000	ns
$\overline{ACKIN}\downarrow$ to $\overline{WAIT}\uparrow$ delay <u>8/</u>	t _{PHL28}	Reference number 87. <u>2/ 3/ 4/</u>	01	9, 10, 11		10*(t _{CYC1}) + 600	ns
Delay from $\overline{RD}\uparrow$ to $\overline{WR}\downarrow$ for no reset <u>1/</u>	t _{SHL16}	Reference number 88. <u>2/ 3/ 4/</u>	All	9, 10, 11	50		ns
Delay from $\overline{WR}\uparrow$ to $\overline{RD}\downarrow$ for no reset <u>1/</u>	t _{SHL17}	Reference number 89. <u>2/ 3/ 4/</u>	All	9, 10, 11	50		ns
Width of \overline{RD} and \overline{WR} low to insure reset	t _{PWL6}	Reference number 90. <u>2/ 3/ 4/</u>	All	9, 10, 11	250		ns
Any input rise time not otherwise specified <u>1/</u>	t _{RI1}	Reference number 91. <u>2/ 3/ 4/</u>	All	9, 10, 11		100	ns
Any input fall time not otherwise specified <u>1/</u>	t _{FI1}	Reference number 92. <u>2/ 3/ 4/</u>	All	9, 10, 11		100	ns

See footnotes at end of table.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 11

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions 4.5 V ≤ V _{CC} ≤ 5.5 V, -55°C ≤ T _C ≤ +125°C unless otherwise specified	Device type	Group A subgroups	Limits		Unit
					Min	Max	
1's catcher high width <u>1/</u> <u>11/</u>	t _{PWH7}	Reference number 93. <u>2/</u> <u>3/</u> <u>4/</u>	01	9, 10, 11	250		ns
			02		170		
Pattern match input valid (bit port) <u>1/</u>	t _{PWL8} , t _{PWH8}	Reference number 94. <u>2/</u> <u>3/</u> <u>4/</u>	01	9, 10, 11	750		ns
			02		500		
Data latched on pattern match setup time (bit port) <u>1/</u>	t _{SHL18} , t _{SLH18}	Reference number 95. <u>2/</u> <u>3/</u> <u>4/</u>	All	9, 10, 11	0		ns
Data latched on pattern match hold time (bit port) <u>1/</u>	t _{HHL17} , t _{HLH17}	Reference number 96. <u>2/</u> <u>3/</u> <u>4/</u>	01	9, 10, 11	1000		ns
					02	650	

1/ Guaranteed if not tested.

2/ The reference number refers to the parameter being measured on figure 3.

3/ See figure 3.

4/ C_L = 50 pF ±10%.

5/ Parameter does not apply to Interrupt Acknowledge transactions.

6/ Float delay is measured to the time when the output has changed 0.5 V with minimum ac load and maximum dc load.

7/ t_{CYC2} is 1 μs or t_{CYC1}, whichever is longer.

8/ The delay is from DAV↓ for three-wire input handshake. The delay is from DAC↑ for three-wire output handshake.

9/ The parameters for the devices in any particular daisy chain must meet the following constraint: The delay from INTACK↓ to RD↓ must be greater than the sum of t_{dIA}(EIO) for the highest priority peripheral, t_{sIEI}(RDA) for the lowest priority peripheral, and t_{dIEI}(IEO) for each peripheral separating them in the chain.

10/ This time can be extended through the use of deskew timers.

11/ If the input is programmed inverting, a low-going pulse of the same width will be detected.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 12

Device types:	01 and 02		
Case outline:	Q		
Terminal number	Terminal name	Terminal number	Terminal name
1	D ₄	21	PC ₂
2	D ₅	22	PC ₃
3	D ₆	23	+5 V
4	D ₇	24	$\overline{\text{INT}}$
5	$\overline{\text{RD}}$	25	$\overline{\text{INTACK}}$
6	$\overline{\text{WR}}$	26	PA ₇
7	GND	27	PA ₆
8	PB ₀	28	PA ₅
9	PB ₁	29	PA ₄
10	PB ₂	30	PA ₃
11	PB ₃	31	PA ₂
12	PB ₄	32	PA ₁
13	PB ₅	33	PA ₀
14	PB ₆	34	A ₀
15	PB ₇	35	A ₁
16	PCLK	36	$\overline{\text{CE}}$
17	IEI	37	D ₀
18	IEO	38	D ₁
19	PC ₀	39	D ₂
20	PC ₁	40	D ₃

FIGURE 1. Terminal connections.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 13

Device types:	01 and 02		
Case outline:	Y		
Terminal number	Terminal name	Terminal number	Terminal name
1	D ₄	23	PC ₂
2	D ₅	24	PC ₃
3	D ₆	25	+5 V
4	D ₇	26	$\overline{\text{INT}}$
5	$\overline{\text{RD}}$	27	$\overline{\text{INTACK}}$
6	NC	28	NC
7	$\overline{\text{WR}}$	29	NC
8	NC	30	PA ₇
9	GND	31	PA ₆
10	PB ₀	32	PA ₅
11	PB ₁	33	PA ₄
12	PB ₂	34	PA ₃
13	PB ₃	35	PA ₂
14	PB ₄	36	PA ₁
15	PB ₅	37	PA ₀
16	PB ₆	38	A ₀
17	PB ₇	39	A ₁
18	PCLK	40	$\overline{\text{CE}}$
19	IEI	41	D ₀
20	IEO	42	D ₁
21	PC ₀	43	D ₂
22	PC ₁	44	D ₃

NC = No connection

FIGURE 1. Terminal connections - Continued.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 14

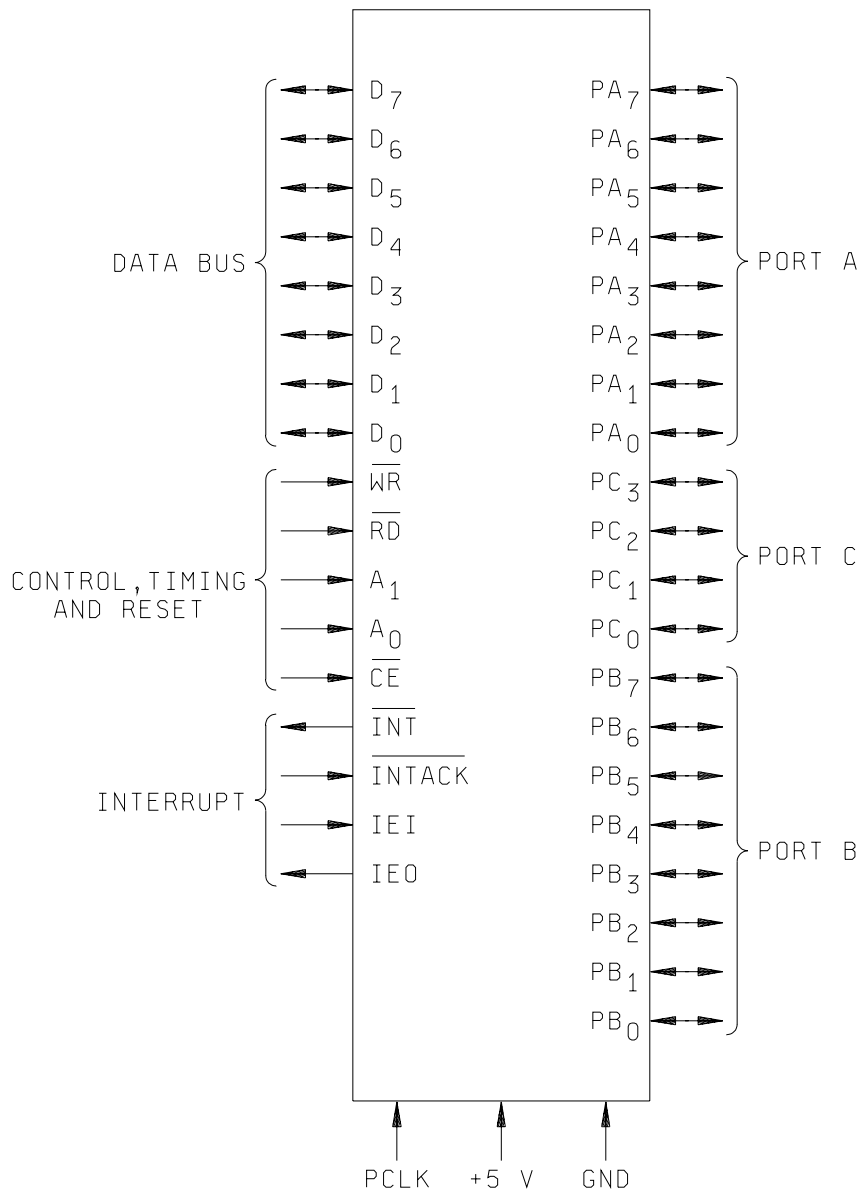
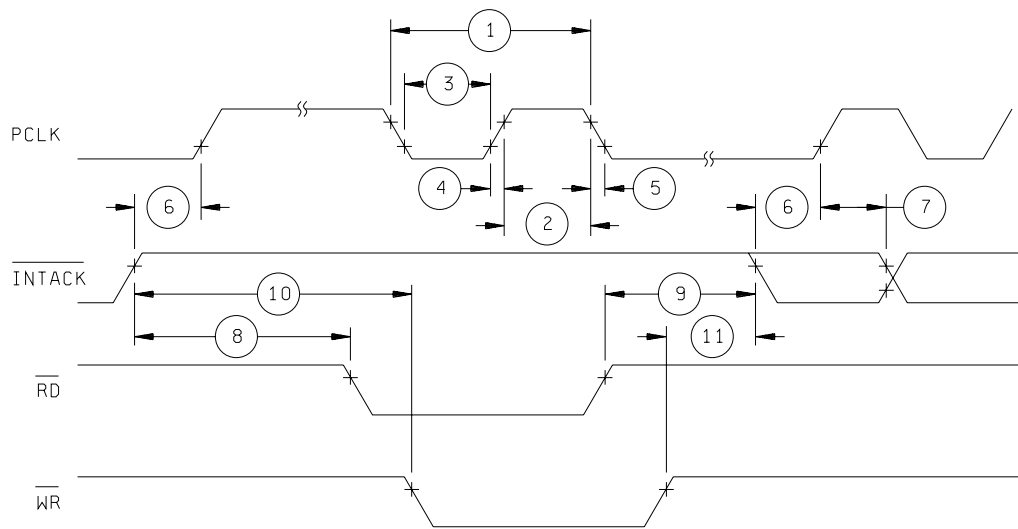
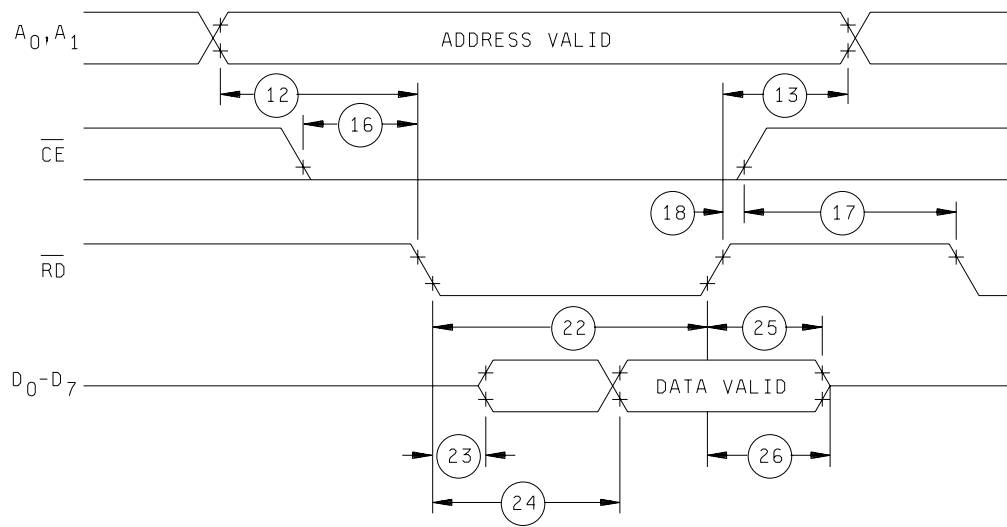


FIGURE 2. Logic functions.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 15



PCLK, INTACK TIMING



READ CYCLE TIMING

FIGURE 3. Timing waveforms.

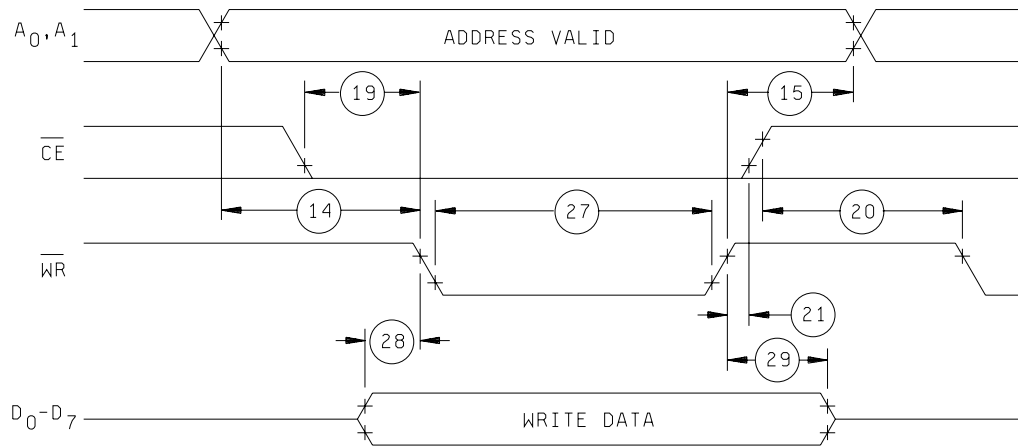
**STANDARD
MICROCIRCUIT DRAWING**
DEFENSE SUPPLY CENTER COLUMBUS
COLUMBUS, OHIO 43218-3990

SIZE
A

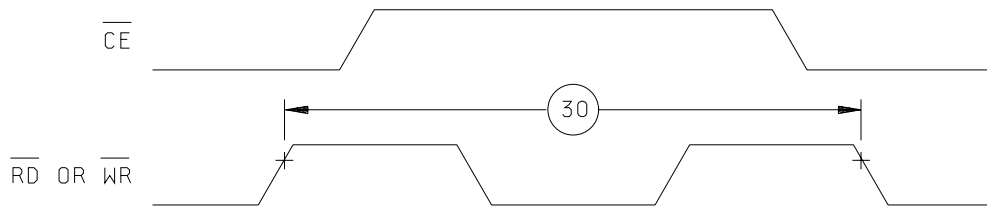
83001

REVISION LEVEL
D

SHEET
16



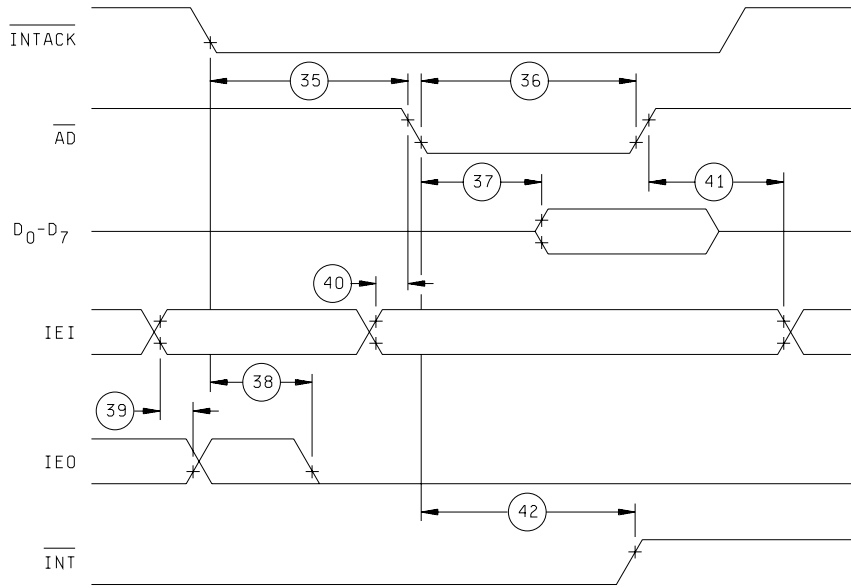
WRITE CYCLE TIMING



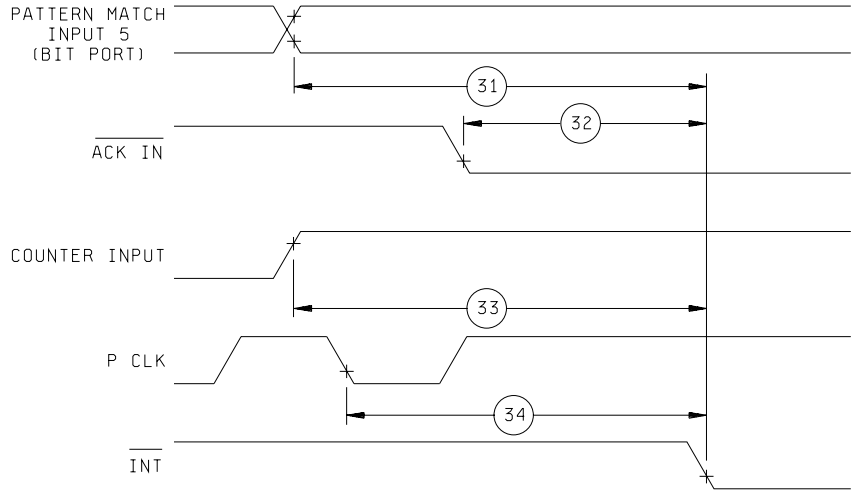
VALID ACCESS RECOVERY TIME

FIGURE 3. Timing waveforms - Continued.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 17



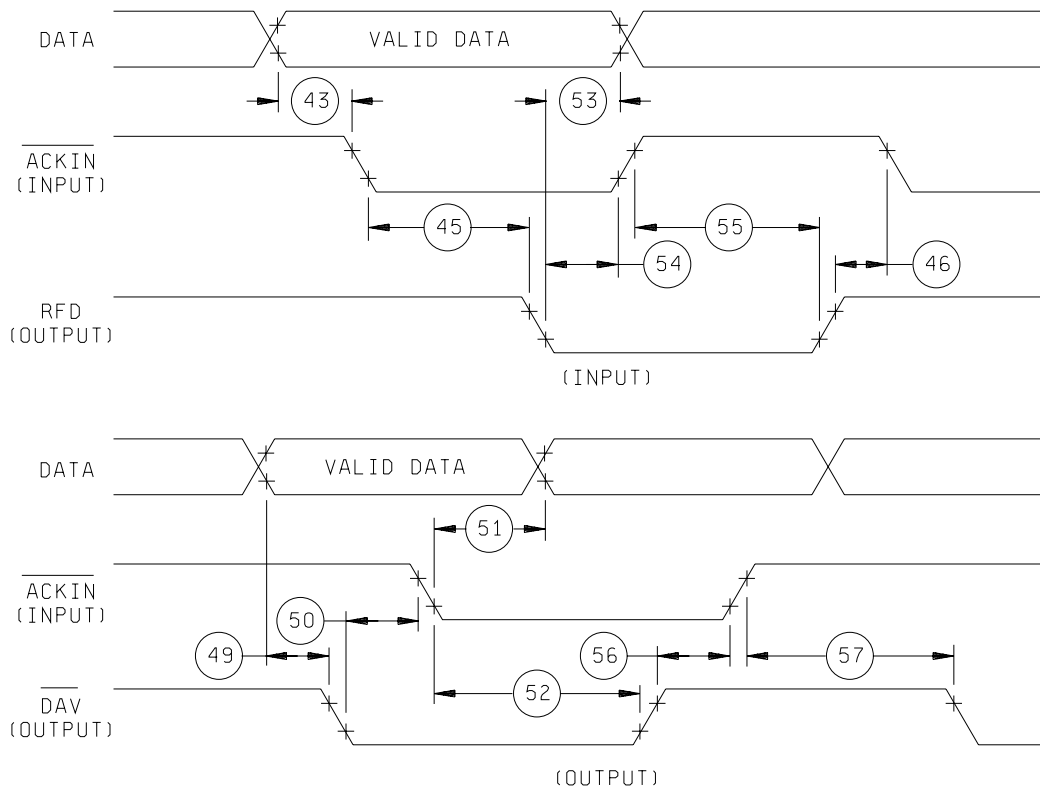
INTERRUPT ACKNOWLEDGE TIMING



INTERRUPT TIMING

FIGURE 3. Timing waveforms - Continued.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 18



INTERLOCK HANDSHAKE TIMING

FIGURE 3. Timing waveforms - Continued.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 19

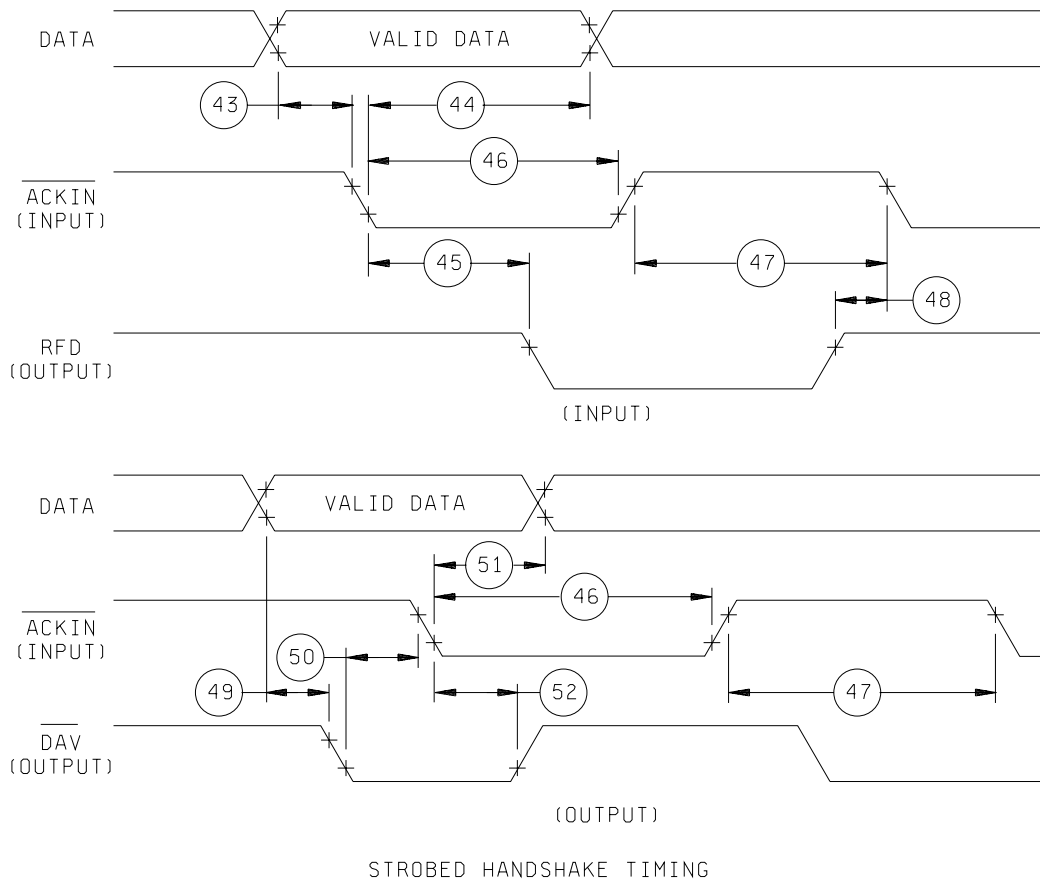
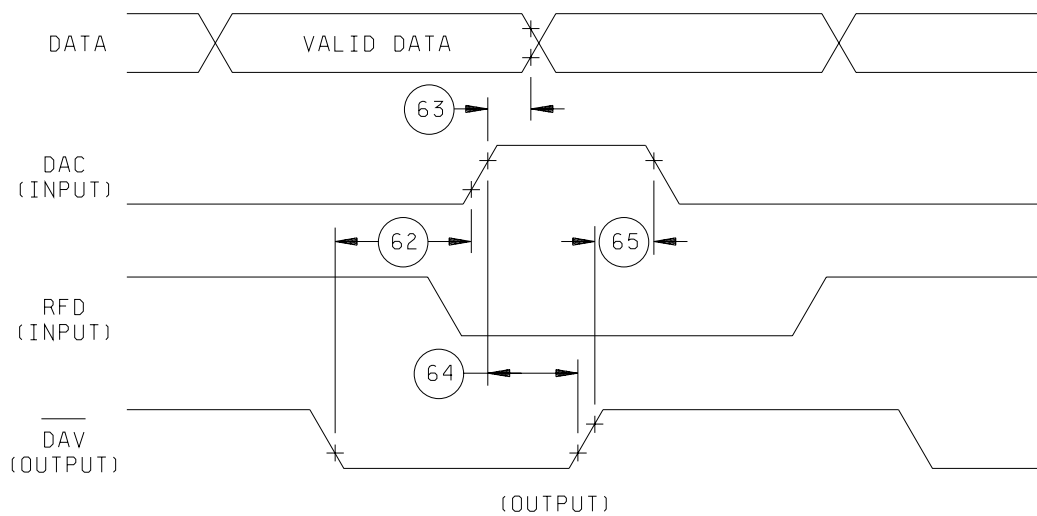
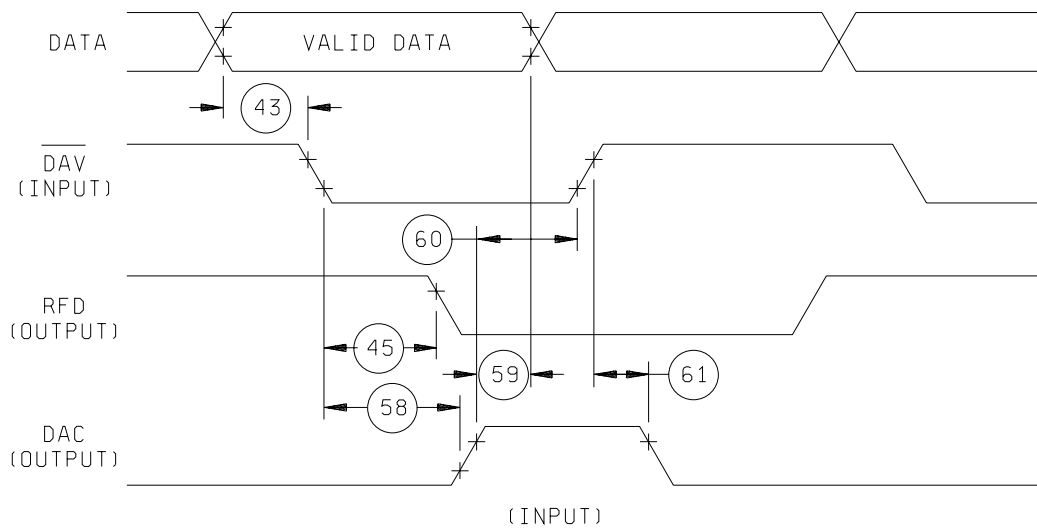


FIGURE 3. Timing waveforms - Continued.

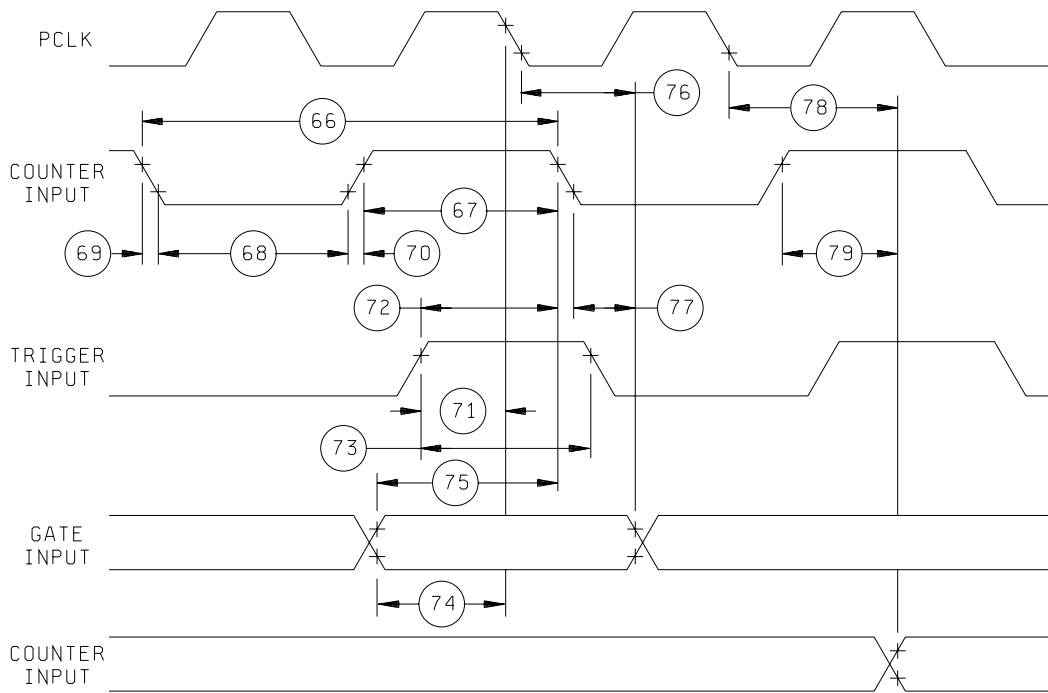
STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 20



THREE-WIRE HANDSHAKE

FIGURE 3. Timing waveforms - Continued.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 21



COUNTER/TIMER TIMING

FIGURE 3. Timing waveforms - Continued.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 22

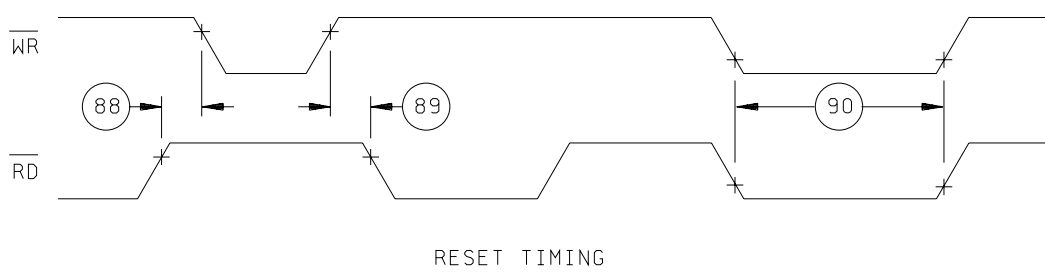
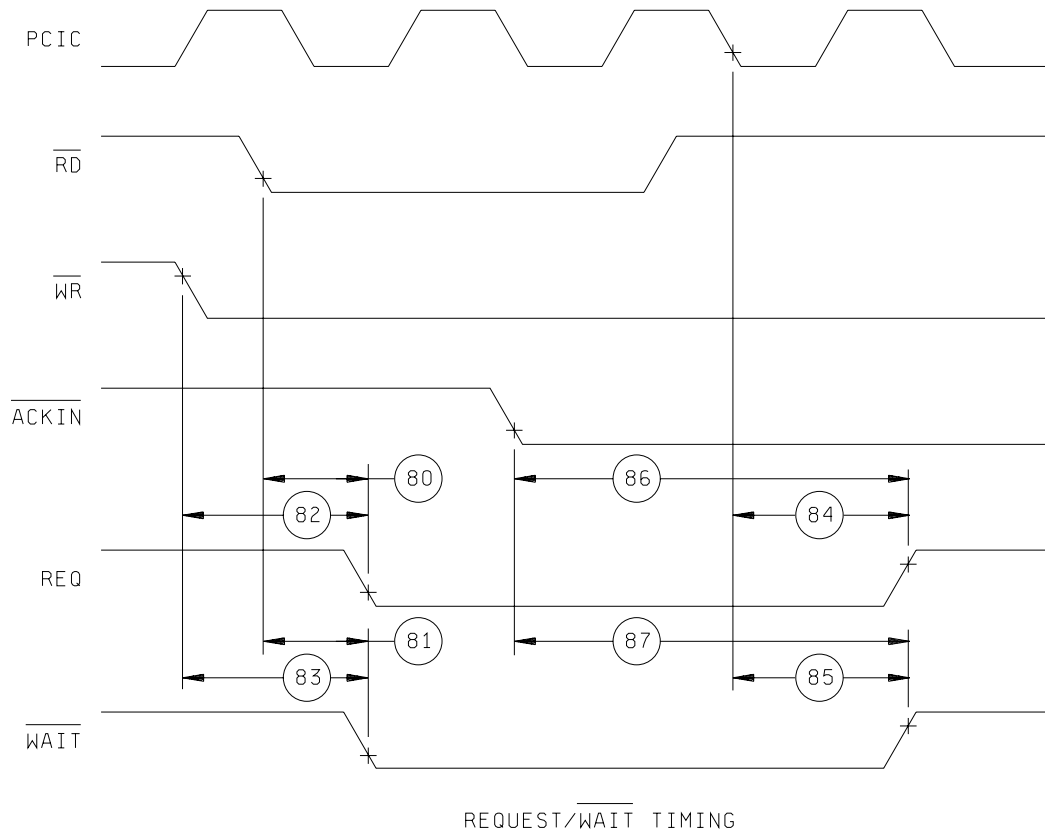
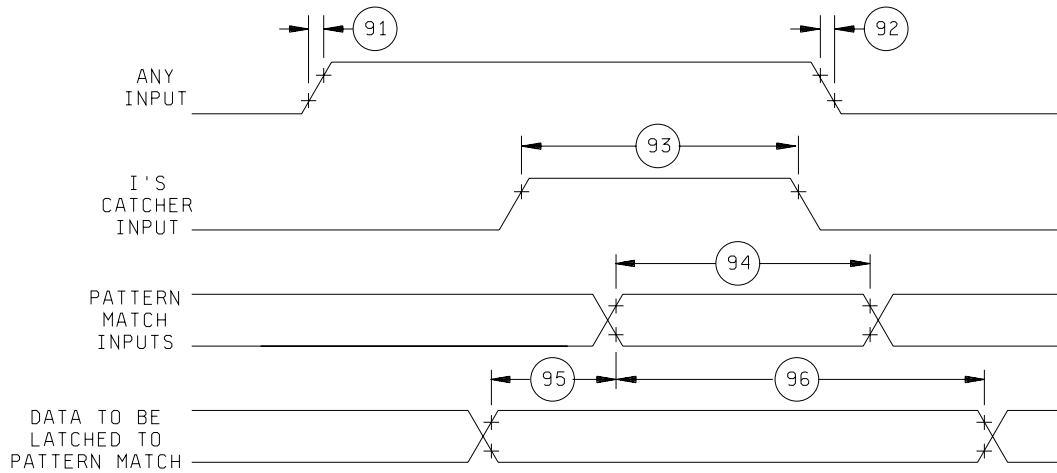


FIGURE 3. Timing waveforms - Continued.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 23



MISCELLANEOUS PORT TIMING

FIGURE 3. Timing waveforms - Continued.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 24

4. VERIFICATION

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.

4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

- a. Burn-in test, method 1015 of MIL-STD-883.
 - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015 of MIL-STD-883.
 - (2) $T_A = +125^\circ\text{C}$, minimum.
- b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (in accordance with MIL-STD-883, method 5005, table I)
Interim electrical parameters (method 5004)	---
Final electrical test parameters (method 5004)	1*, 2, 3, 9
Group A test requirements (method 5005)	1, 2, 3, 7, 8, 9, 10, 11**
Groups C and D end-point electrical parameters (method 5005)	1, 2, 3

* PDA applies to subgroup 1.

** Subgroups 10 and 11, if not tested, shall be guaranteed to the specified limits in table I.

4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

4.3.1 Group A inspection.

- a. Tests shall be as specified in table II herein.
- b. Subgroups 5 and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.
- c. Subgroup 7 functional test shall include verification of programming set.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 25

4.3.2 Groups C and D inspections.

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test conditions, method 1005 of MIL-STD-883.
 - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1005 of MIL-STD-883.
 - (2) $T_A = +125^{\circ}\text{C}$, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38535, appendix A.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.3 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished using DD Form 1692, Engineering Change Proposal.

6.4 Record of users. Military and industrial users shall inform Defense Supply Center Columbus (DSCC) when a system application requires configuration control and the applicable SMD. DSCC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DSCC-VA, telephone (614) 692-0544.

6.5 Comments. Comments on this drawing should be directed to DSCC-VA, Columbus, Ohio 43218-3990, or telephone (614) 692-0547.

6.6 Approved sources of supply. Approved sources of supply are listed in MIL-HDBK-103. The vendors listed in MIL-HDBK-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DSCC-VA.

6.7 Terminal and functional definitions. Terminal and functional definitions and descriptions for this device shall be as follows:

- IEI Interrupt enable in (input, active high). When this line is active, the CIO is able to interrupt the CPU.
- IEO Interrupt enable out (output, active high). This output is high only if IEI is high and the CPU is not servicing an interrupt from this CIO. In conjunction with IEI, this line can be used to implement a system-wide interrupt priority daisy chain.
- INT Interrupt request (output, open drain, active low). This signal is pulled low when the CIO requests an interrupt.
- INTACK Interrupt acknowledge (input, active low). This signal indicates to the CIO that an interrupt acknowledge cycle is in progress. INTACK must be synchronized to P clock.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 26

- PA₀-PA₇ Port A I/O lines (bidirectional, tri-state or open drain). These eight I/O lines transfer information between the CIO's port A and external devices.
- PB₀-PB₇ Port B I/O lines (bidirectional, tri-state or open drain). These eight I/O lines transfer information between the CIO's port B and external devices. They also provide external access to counter/timers 1 and 2.
- PC₀-PC₃ Port C I/O lines (bidirectional, tri-state or open drain). These four I/O lines are used to provide handshake, WAIT, and REQUEST lines for ports A and B, to provide external access to counter/timer 3 or to the CIO's port C.
- PCLK Peripheral clock (input, TTL compatible). This is a peripheral clock that may be, but is not necessarily the CPU clock. It is used with the timers and the REQUEST/WAIT logic. The maximum input frequency is 4 MHz.
- A₀-A₁ Address lines (input). These two lines are used to select the register involved in a data transaction between the CIO and CPU.
- $\overline{\text{CE}}$ Chip enable (input, active low). A low level on this input enables the CPU to be read from or written to.
- D₀-D₇ Data bus (bidirectional, tri-state). These eight data lines are used for transfers between the CPU and the CIO.
- $\overline{\text{RD}}^*$ Read (input, active low). This signal indicates that a CPU is reading from the CIO. During an INT ACK cycle, gates the interrupt vector on to the data bus.
- $\overline{\text{WR}}^*$ Write (input, active low). This signal indicates a CPU write to the CIO.
- * When $\overline{\text{RD}}$ and $\overline{\text{WR}}$ are detected low at the same time (normally an illegal condition) the device is reset.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43218-3990	SIZE A		83001
		REVISION LEVEL D	SHEET 27

STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 05-03-23

Approved sources of supply for SMD 83001 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DSCC-VA. This information bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535. DSCC maintains an online database of all current sources of supply at <http://www.dscclia.mil/Programs/Smcr/>.

Standard microcircuit drawing PIN <u>1/</u>	Vendor CAGE number	Vendor similar PIN <u>2/</u>
8300101QA	0C7V7	Z0853604CMB
8300101YA	0C7V7	Z0853604LMB
8300102QA	0C7V7	Z0853606CMB
8300102YA	0C7V7	Z0853606LMB

1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the vendor to determine its availability.

2/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE number

0C7V7

Vendor name and address

QP semiconductor
2945 Oakmead Village Court
Santa Clara, CA 95051

The information contained herein is disseminated for convenience only and the Government assumes no liability whatsoever for any inaccuracies in the information bulletin.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [Processors - Application Specialized category:](#)

Click to view products by [E2v manufacturer:](#)

Other Similar products are found below :

[MCIMX27MOP4A](#) [MCIMX6D5EYM12AD](#) [MCIMX250DJM4A](#) [MCIMX6L3EVN10AB](#) [MCIMX6L7DVN10AB](#) [MCIMX6L8DVN10ABR](#)
[MCIMX31CJMN4D](#) [T1042NSN7PQB](#) [MCIMX507CVK8B](#) [MCIMX355AJQ5C](#) [MCIMX355AJQ5C](#) [MCIMX6Q4AVT10AD](#)
[MCIMX6Q4AVT10AD](#) [MCIMX253DJM4A](#) [MCIMX31CVKN5D](#) [AT97SC3205P-SDK2](#) [AT97SC3205T-SDK2](#) [MCIMX6X1CVO08AB](#)
[MCIMX353CJQ5C](#) [MC9328MXLVM15](#) [MCIMX6Q6AVT08AC](#) [MCIMX6L8DVN10AB](#) [MIMX8MQ6DVAJZAA](#) [MCIMX233DJM4C](#)
[MIMX8MD6CVAHZAA](#) [MCIMX6V2CVM08AB](#) [MCIMX6G2CVK05AB](#) [MC9328MXLCVM15](#) [MCIMX6G3CVM05AB](#)
[MCIMX6G2CVM05AB](#) [MCIMX6G3CVK05AB](#) [MCIMX6G1AVM07AA](#) [MCIMX6G1AVM07AB](#) [MCIMX6G1AVM05AB](#)
[MCIMX6V7DVN10AB](#) [MCIMX6G2DVK05AB](#) [MCIMX535DVV1C2](#) [GOLDELOX](#) [PICASO](#) [AGB75LC04-QU-E](#) [AT97SC3204-U2A16-00](#)
[MCIMX6L2DVN10AA](#) [P2041NSE7PNC](#) [MCIMX6X2EVN10ABR](#) [BM94803AEKU-Z](#) [MCIMX31CJMN4C](#) [MCIMX31CVKN5D](#)
[MC9328MXLVM20](#) [MCIMX233CJM4C](#) [MCIMX233DAG4C](#)